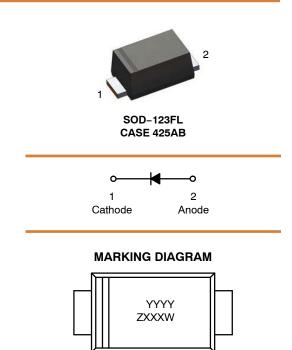
onsemi

Super Fast Surface Mount Rectifiers US1AFA-US1MFA

Features

- Glass Passivated Chip Junction
- Low Power Loss, High Efficiency
- Fast Switching Reverse Recovery Time: 50~75 ns Maximum
- High Surge Capacity
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



- YYYY = Binary Calendar Year Code Scheme
 - = Assembly Plant Code

Ζ

W

- XXX = Specific Device Code
 - = Single Digit Week Code

ORDERING INFORMATION

Part Number	Device Code Marking	Package	Shipping [†]		
US1AFA, NRVUS1AFA*	HAL	SOD-123FL	3,000 / Tape & Reel		
US1BFA, NRVUS1BFA*	HBL	(Pb-Free / Halogen Free)			
US1DFA, NRVUS1DFA*	HDL				
US1FFA, NRVUS1FFA*	HFL				
US1GFA, NRVUS1GFA*	HGL				
US1JFA, NRVUS1JFA*	HJL				
US1KFA, NRVUS1KFA*	HKL				
US1MFA, NRVUS1MFA*	HML	1			

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable

© Semiconductor Components Industries, LLC, 2015 February, 2022 – Rev. 4

US1AFA-US1MFA

ABSOLUTE MAXIMUM RATINGS (Values are at $T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	US1 AFA	US1 BFA	US1 DFA	US1 FFA	US1 GFA	US1 JFA	US1 KFA	US1 MFA	Unit
V _{RRM}	Repetitive Peak Reverse Voltage		100	200	300	400	600	800	1000	V
V _{RMS}	RMS Reverse Voltage		70	140	210	280	420	560	700	V
V _R	DC Blocking Voltage	50	100	200	300	400	600	800	1000	V
I _{F(AV)}	Average Forward Rectified Current				А					
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	30		A						
TJ	Operating Junction Temperature Range	–55 to +150		°C						
T _{STG}	Storage Temperature Range	–55 to +150				°C				

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS (Values are at $T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Value	Unit	
Ψ_{JL}	Typical Thermal Resistance, Junction to Lead	21	°C/W	
$R_{\theta JA}$	Typical Thermal Resistance, Junction to Ambient	153	°C/W	

NOTE: Device mounted at minimum pad.

ELECTRICAL CHARACTERISTICS (Values are at $T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Conditions	US1 AFA	US1 BFA	US1 DFA	US1 FFA	US1 GFA	US1 JFA	US1 KFA	US1 MFA	Unit
V _F	Maximum Instantaneous Forward Voltage (Note 1)	I _F = 1 A	0.95 1.30		1.70		V				
I _R	Maximum Reverse Current at	T _J = 25°C	5							μA	
	Rated V _R	T _J = 125°C	150								
CJ	Typical Junction Capacitance	V _R = 4.0 V, f = 1.0 MHz	20			15			pF		
T _{rr}	Maximum Reverse Recovery Time	$I_{\rm F} = 0.5 {\rm A},$ $I_{\rm R} = 1 {\rm A},$ $I_{\rm rr} = 0.25 {\rm A}$	50			75			ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse test with PW = 300 μ s, 1% duty cycle.

US1AFA-US1MFA

TYPICAL PERFORMANCE CHARACTERISTICS

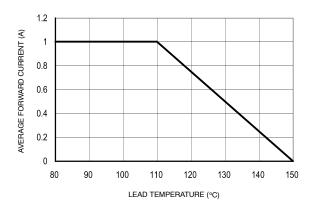


Figure 1. Maximum Forward Current Derating Voltage

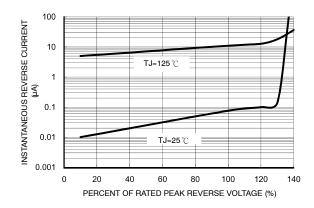


Figure 2. Typical Reverse Characteristics

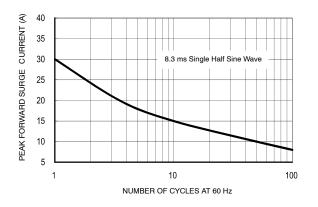


Figure 3. Maximum Non-Repetitive Forward Surge Current

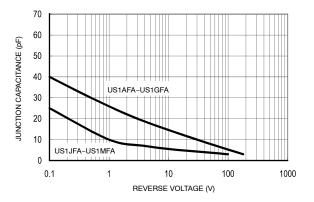


Figure 5. Typical Junction Capacitance

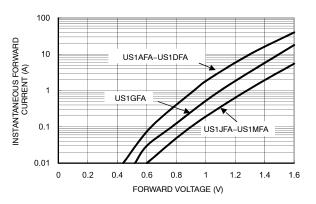


Figure 4. Typical Instantaneous Forward Characteristics

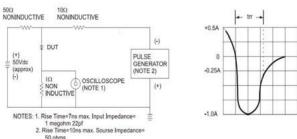
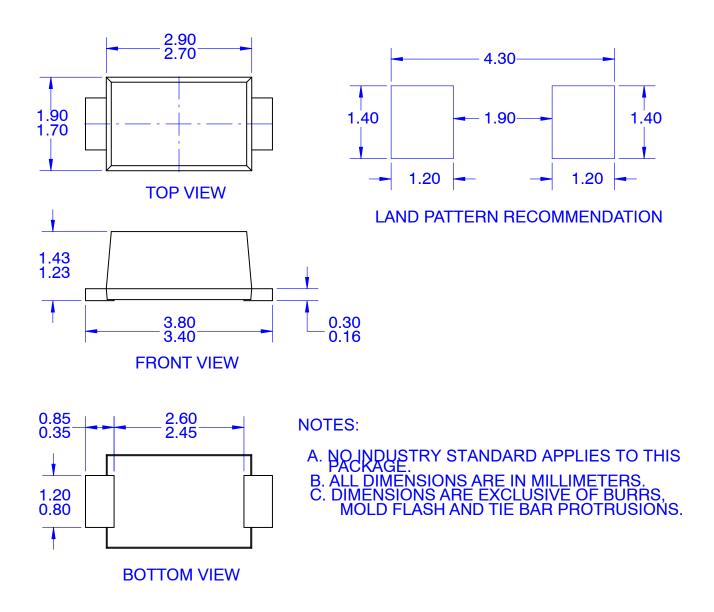


Figure 6. Reverse Recovery Time Characteristic and Test Circuit Diagram



SOD-123FL CASE 425AB ISSUE O

DATE 31 AUG 2016



DOCUMENT NUMBER:	98AON13722G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.						
DESCRIPTION:	SOD-123FL	PAGE 1 OF						
ON Semiconductor and ()) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.								

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

 \Diamond